

S/N 10/675,921

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Yin Men Lai et al.

Examiner: Scott Geyer

Serial No.: 10/675,921

Group Art Unit: 2812

Filed: September 30, 2003

Docket No.: 884.A65US1

Title: CAPILLARY UNDERFILL AND MOLD ENCAPSULATION METHOD AND
APPARATUS

Assignee: Intel Corporation

Customer Number: 21186

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

MS Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

This responds to the Office Action mailed on December 4, 2006. Please amend the
above-identified patent application as follows.